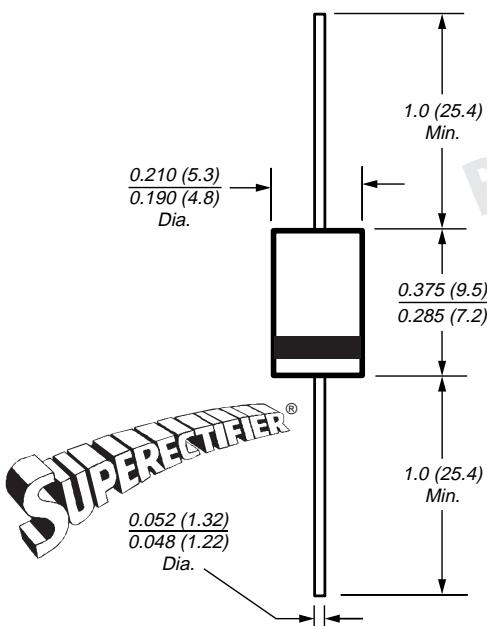



**DO-201AD**

## Glass Passivated Junction Fast Switching Rectifier

 Reverse Voltage 50 to 1000V  
 Forward Current 2.5A


Dimensions in inches and (millimeters)

\* Glass-plastic encapsulation technique is covered by  
 Patent No. 3,996,602 and brazed-lead assembly by Patent No. 3,930,306

### Features

- Plastic package has Underwriters Laboratories Flammability Classification 94V-0
- High temperature metallurgically bonded construction
- Cavity-free glass passivated junction
- 2.5 Ampere operation at  $T_A=55^\circ\text{C}$  with no thermal runaway
- Typical  $I_R$  less than  $0.2\mu\text{A}$
- Capable of meeting environmental standards of MIL-S-19500
- High temperature soldering guaranteed:  $350^\circ\text{C}/10$  seconds, 0.375" (9.5mm) lead length, 5 lbs. (2.3kg) tension

### Mechanical Data

**Case:** JEDEC DO-201AD, molded plastic over glass body

**Terminals:** Plated axial leads, solderable per MIL-STD-750, Method 2026

**Polarity:** Color band denotes cathode end

**Mounting Position:** Any

**Weight:** 0.04 oz., 1.12 g

**Packaging codes/options:**

1/Bulk - 1.5K per container, 15K per box

4/1.4K per 13" reel, 5.6K per box

23/1K per Ammo. mag., 9K per box

### Maximum Ratings & Thermal Characteristics

 Ratings at  $25^\circ\text{C}$  ambient temperature unless otherwise specified.

Parameter	Symbol	RGP 25A	RGP 25B	RGP 25D	RGP 25G	RGP 25J	RGP 25K	RGP 25M	Unit
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	V
Maximum average forward rectified current 0.375" (9.5mm) lead length at $T_A=55^\circ\text{C}$	I <sub>F(AV)</sub>					2.5			A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I <sub>FSM</sub>				100				A
Maximum full load reverse current, full cycle average 0.375" (9.5mm) lead length at $T_A=55^\circ\text{C}$	I <sub>R(AV)</sub>			100					$\mu\text{A}$
Typical thermal resistance <sup>(1)</sup>	R <sub>θJA</sub>			20					$^\circ\text{C/W}$
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>			-65 to +175					$^\circ\text{C}$

### Electrical Characteristics

 Ratings at  $25^\circ\text{C}$  ambient temperature unless otherwise specified.

Maximum instantaneous forward voltage at 2.5A	V <sub>F</sub>	1.3				V
Maximum DC reverse current $T_A=25^\circ\text{C}$ at rated DC blocking voltage $T_A=125^\circ\text{C}$	I <sub>R</sub>	5.0 200				$\mu\text{A}$
Maximum reverse recovery time $I_F=0.5\text{A}$ , $I_R=1.0\text{A}$ , $I_{rr}=0.25\text{A}$	t <sub>rr</sub>	150		250	500	ns
Typical junction capacitance at 4.0V, 1MHz	C <sub>J</sub>	60				pF

Notes: (1) Thermal resistance from junction to ambient at 0.375" (9.5mm) lead length, P.C.B. mounted

# RGP25A THRU RGP25M

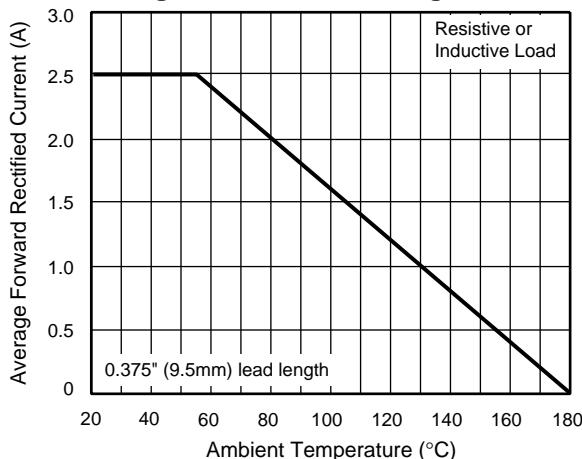


Vishay Semiconductors  
formerly General Semiconductor

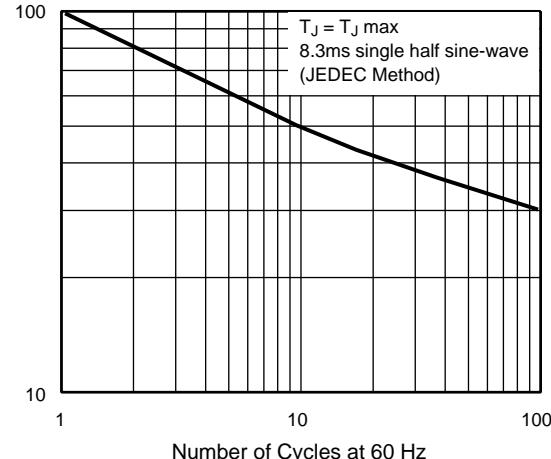
## Ratings and Characteristic Curves

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

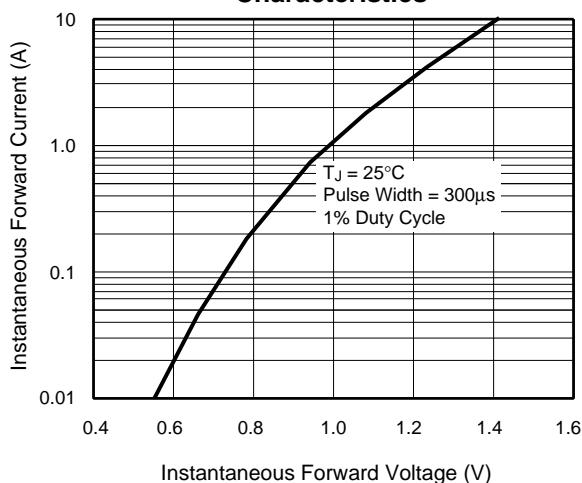
**Fig. 1 - Forward Derating Curve**



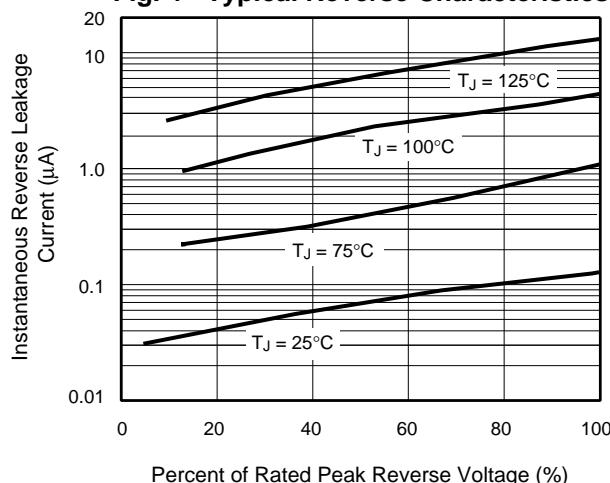
**Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current**



**Fig. 3 - Typical Instantaneous Forward Characteristics**



**Fig. 4 - Typical Reverse Characteristics**



**Fig. 5 - Typical Junction Capacitance**

